

CY7C1019BV33

128K x 8 Static RAM

Features

- High speed-t_{AA} = 10 ns
- · CMOS for optimum speed/power
- Center power/ground pinout
- Automatic power-down when deselected
- Easy memory expansion with CE and OE options
- Functionally equivalent to CY7C1019V33

Functional Description

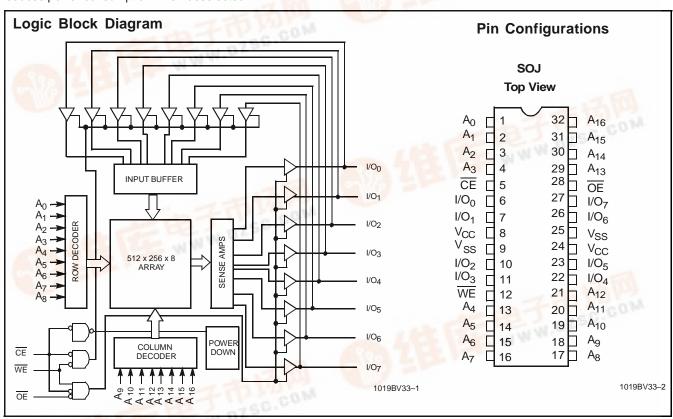
The CY7C1019BV33 is a high-performance CMOS static RAM organized as 131,072 words by 8 bits. Easy memory expansion is provided by an active LOW Chip Enable (CE), an active LOW Output Enable (OE), and three-state drivers. This device has an automatic power-down feature that significantly reduces power consumption when deselected.

<u>Writing</u> to the device is <u>ac</u>complished by taking Chip Enable ($\overline{\text{CE}}$) and Write Enable ($\overline{\text{WE}}$) inputs LOW. Data on the eight I/O pins (I/O₀ through I/O₇) is then written into the location specified on the address pins (A₀ through A₁₆).

Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O $_0$ through I/O $_7$) are placed in a high-impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation (CE LOW, and WE LOW).

The CY7C1019BV33 is available in a standard 400-mil-wide package.



Selection Guide

10/10/11		7C1019BV33-10	7C1019BV33-12	7C1019BV33-15
Maximum Access Time (ns)		10	12	15
Maximum Operating Current (mA)		175	160	145
Maximum Standby Current (mA)		5	5	5
支 PDF	L	_	0.5	0.5



Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied–55°C to +125°C Supply Voltage on V_{CC} to Relative ${\rm GND}^{[1]}$ –0.5V to +7.0V DC Voltage Applied to Outputs in High Z State $^{[1]}$ -0.5V to V CC + 0.5V DC Input Voltage^[1].....-0.5V to V_{CC} + 0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage	>2001V
(per MIL-STD-883, Method 3015)	
Latch-Up Current	>200 mA

Operating Range

Range	Ambient Temperature ^[2]	v _{cc}
Commercial	0°C to +70°C	3.3V ± 10%

Electrical Characteristics Over the Operating Range

		Test Conditions		7C1019BV33 -10		7C1019BV33 -12		7C1019BV33 -15		
Parameter	Description			Min. Ma		Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min.,$ $I_{OH} = -4.0 \text{ mA}$		2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA			0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage			2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	V
V_{IL}	Input LOW Voltage[1]			-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I _{IX}	Input Load Current	$GND \leq V_{I} \leq V_{CC}$		-1	+1	-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	$GND \le V_I \le V_{CC}$, Output Disabled		- 5	+5	- 5	+5	- 5	+5	μА
I _{CC}	V _{CC} Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0 \text{ mA},$ $f = f_{MAX} = 1/t_{RC}$			175		160		145	mA
I _{SB1}	Automatic CE Power-Down Current —TTL Inputs	$\begin{aligned} &\text{Max. V}_{\text{CC}}, \overline{\text{CE}} \geq \text{V}_{\text{IH}} \\ &\text{V}_{\text{IN}} \geq \text{V}_{\text{IH}} \text{ or} \\ &\text{V}_{\text{IN}} \leq \text{V}_{\text{IL}}, \text{ f} = \text{f}_{\text{MAX}} \end{aligned}$			20		20		20	mA
I _{SB2}	Automatic CE	Max. V _{CC} ,			5		5		5	mA
	Power-Down Current —CMOS Inputs	$CE \ge V_{CC} - 0.3V,$ $V_{IN} \ge V_{CC} - 0.3V,$ or $V_{IN} \le 0.3V,$ f = 0	L		-		0.5		0.5	

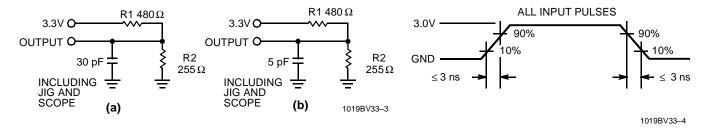
Capacitance^[3]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C$, $f = 1$ MHz,	6	pF
C _{OUT}	Output Capacitance	$V_{CC} = 5.0V$	8	pF

- 1. V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
- T_A is the "Instant On" case temperature.
 Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms



THÉVENIN EQUIVALENT Equivalent to:

Switching Characteristics^[4] Over the Operating Range

		7C1019	BV33-10	7C1019	BV33-12	7C1019	BV33-15	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYCL	E	4					1	
t _{RC}	Read Cycle Time	10		12		15		ns
t _{AA}	Address to Data Valid		10		12		15	ns
t _{OHA}	Data Hold from Address Change	3		3		3		ns
t _{ACE}	CE LOW to Data Valid		10		12		15	ns
t _{DOE}	OE LOW to Data Valid		5		6		7	ns
t _{LZOE}	OE LOW to Low Z	0		0		0		ns
t _{HZOE}	OE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{LZCE}	CE LOW to Low Z ^[6]	3		3		3		ns
t _{HZCE}	CE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{PU}	CE LOW to Power-Up	0		0		0		ns
t _{PD}	CE HIGH to Power-Down		10		12		15	ns
WRITE CYCI	E ^[7, 8]	•						
t _{WC}	Write Cycle Time	10		12		15		ns
t _{SCE}	CE LOW to Write End	8		9		10		ns
t _{AW}	Address Set-Up to Write End	7		8		10		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		ns
t _{PWE}	WE Pulse Width	7		8		10		ns
t _{SD}	Data Set-Up to Write End	5		6		8		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[6]	3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[5, 6]		5		6		7	ns

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.

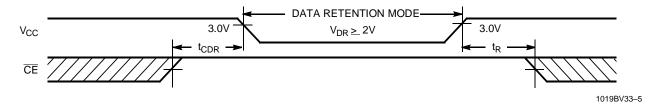
- t_{HZOE}, t_{HZCE}, and t_{HZWE} are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage. At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZOE} is less than t_{LZOE}, and t_{HZWE} is less than t_{LZWE} for any given device. The internal write time of the memory is defined by the overlap of CE LOW and WE LOW. CE and WE must be LOW to initiate a write, and the transition of any of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write. The minimum write cycle time for Write Cycle no. 3 (WE controlled, OE LOW) is the sum of t_{HZWE} and t_{SD}. 7.



Data Retention Characteristics Over the Operating Range (L Version Only)

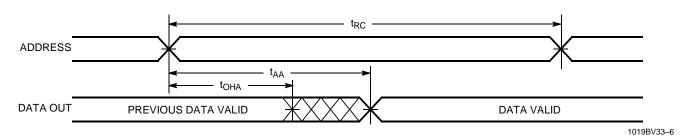
Parameter	Description	Conditions	Min.	Max.	Unit
V_{DR}	V _{CC} for Data Retention	No input may exceed V _{CC} + 0.5V	2.0		V
I _{CCDR}	Data Retention Current	$\frac{V_{CC}}{CE} = V_{DR} = 2.0V,$ $CE \ge V_{CC} - 0.3V,$		150	μΑ
t _{CDR} ^[3]	Chip Deselect to Data Retention Time	$V_{\text{IN}} \ge V_{\text{CC}} - 0.3 \text{V or } V_{\text{IN}} \le 0.3 \text{V}$	0		ns
t _R	Operation Recovery Time		200		μs

Data Retention Waveform

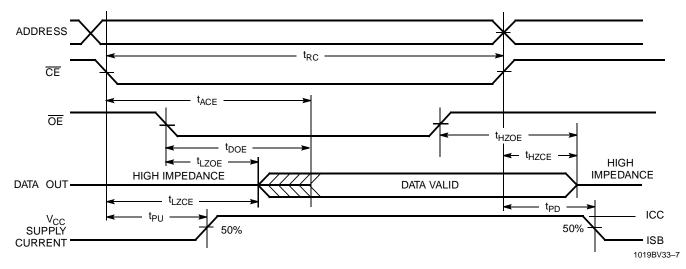


Switching Waveforms

Read Cycle No. 1^[9, 10]



Read Cycle No. 2 (OE Controlled)[10, 11]



- 9. Device is continuously selected. \overline{OE} , $\overline{CE} = V_{|L}$.

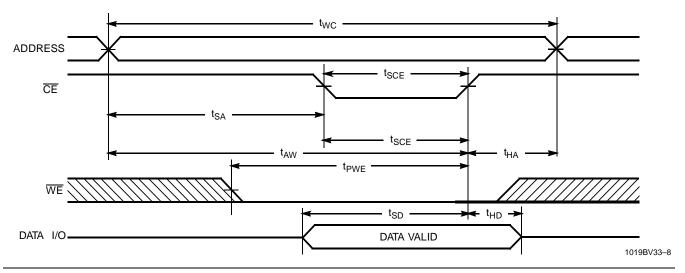
 10. \overline{WE} is HIGH for read cycle.

 11. Address valid prior to or coincident with \overline{CE} transition LOW.

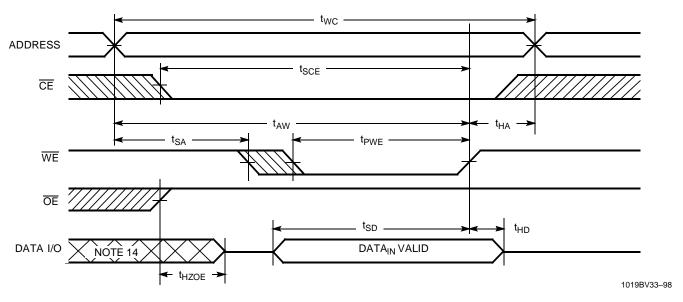


Switching Waveforms (continued)

Write Cycle No. 1 (CE Controlled)[12, 13]



Write Cycle No. 2 (WE Controlled, OE HIGH During Write)[12, 13]

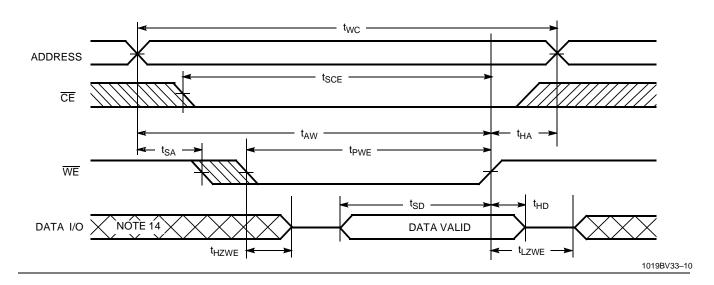


- 12. Data I/O is high impedance if OE = V_{IH}.
 13. If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.
 14. During this period the I/Os are in the output state and input signals should not be applied.



Switching Waveforms (continued)

Write Cycle No. 3 ($\overline{\text{WE}}$ Controlled, $\overline{\text{OE}}$ LOW)^[13]



Truth Table

CE	OE	WE	I/O ₀ –I/O ₇	Mode	Power
Н	Х	Χ	High Z	Power-Down	Standby (I _{SB})
Х	Х	Χ	High Z	Power-Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I _{CC})

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C1019BV33-10VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
12	CY7C1019BV33-12VC	V33	32-Lead 400-Mil Molded SOJ	
	CY7C1019BV33L-12VC	V33	32-Lead 400-Mil Molded SOJ	
15	CY7C1019BV33-15VC	V33	32-Lead 400-Mil Molded SOJ	
	CY7C1019BV33L-15VC	V33	32-Lead 400-Mil Molded SOJ	
	CY7C1019BV33-15VI	V33	32-Lead 400-Mil Molded SOJ	Industrial

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Package Diagram

32-Lead (400-Mil) Molded SOJ V33

